



## Material Content Data Sheet



<b>Sales Product Name</b>	TLE8251VSJ			<b>Issued</b>	20. July 2018			
<b>MA#</b>	MA001412352							
<b>Package</b>	PG-DSO-8-64			<b>Weight*</b>	81.52 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.493	1.83	1.83	18310	18310
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		107	
	non noble metal	zinc	7440-66-6	0.035	0.04		427	
	non noble metal	iron	7439-89-6	0.696	0.85		8535	
wire	non noble metal	copper	7440-50-8	28.249	34.65	35.55	346538	355607
	non noble metal	copper	7440-50-8	0.079	0.10		969	
	noble metal	palladium	7440-05-3	0.001	0.00	0.10	10	979
encapsulation	organic material	carbon black	1333-86-4	0.145	0.18		1781	
	plastics	epoxy resin	-	5.661	6.94		69450	
	inorganic material	silicondioxide	60676-86-0	42.581	52.25	59.37	522361	593592
leadfinish	noble metal	gold	7440-57-5	0.022	0.03		267	
	noble metal	palladium	7440-05-3	0.014	0.02		166	
	non noble metal	nickel	7440-02-0	0.477	0.59	0.64	5857	6290
plating	noble metal	gold	7440-57-5	0.061	0.07		747	
	noble metal	palladium	7440-05-3	0.038	0.05		464	
	non noble metal	nickel	7440-02-0	1.333	1.63	1.75	16348	17559
glue	plastics	epoxy resin	-	0.156	0.19		1916	
	noble metal	silver	7440-22-4	0.468	0.57	0.76	5747	7663
*deviation	< 10%			Sum in total:		100.00		1000000

### Important Remarks:

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